

CHIP COIL (CHIP INDUCTOR) for Consumer equipment & Industrial equipment LQW15AN == 80 = REFERENCE SPECIFICATION

1. Scope

This reference specification applies to chip coil (chip inductor) LQW15AN_80 series.

1.1 Specific applications:

- Power equipment: Products that can be used in power equipment such as renewable energy equipment, energy storage
 equipment and EV charging equipment and whose functions are not directly related to the protection of human life and
 property.
- Industrial equipment: Products that can be used in industrial equipment such as base stations, manufacturing equipment, industrial robotics equipment, and measurement equipment, and whose functions do not directly relate to the protection of human life and property.
- Medical equipment (GHTF Class C) *Except for implant/surgery/auto injector: Products that can be used for medical
 equipment of Class C of the international classification class GHTF and whose malfunction is considered to pose a
 relatively high risk to the human body.
- Medical equipment (GHTF Class A and B): Products that can be used for medical equipment regulated by Class A and Class B of the international classification class GHTF and whose functions do not directly relate to the protection of human life and property.
- Consumer equipment: Products that can be used in consumer equipment such as home appliances, audio/visual equipment, communication equipment, information equipment, office equipment, and household robotics, and whose functions are not directly related to the protection of human life and property.

1.2 Unsuitable application:

Applications listed in "Limitation of applications" in this reference specification.

2. Part Numbering

(EX.)									
LQ	W	15	A	N	1N3	C	8	0	D
Product	Structure	Dimension	Application	Category	Inductance	Tolerance	Performance	Electrode	Packaging
ID		$(L \times W)$	and					specification	D: taping
			characteristic						*B: bulk
ID	Structure		and	Category	inductance	Tolerance	renormance		D: tapir

^{*}B: Bulk packing is also available (taping condition: however, products without reels are put in plastic bags).

3. Part Number and Rating

Operating temperature range	-55°C to +125°C				
Storage temperature range	-55°C to +125°C				

		Inductance			DC	Self-resonant	Rated
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	resistance (Ω max.)	frequency (GHz min.)	current (mA)*1
	LQW15AN1N3C80D	1.3	C: ±0.2 nH	20	0.012	18.0	3150
	LQW15AN1N3D80D	1.3	D: ±0.5 nH	20	0.012	18.0	3150
	LQW15AN1N5C80D	1.5	C: ±0.2 nH	20	0.028	18.0	2100
	LQW15AN1N5D80D	1.5	D: ±0.5 nH	20	0.028	18.0	2100
	LQW15AN1N6C80D	1.6	C: ±0.2 nH	20	0.045	18.0	1450
	LQW15AN1N6D80D	1.6	D: ±0.5 nH	20	0.045	18.0	1450
	LQW15AN1N7C80D	1.7	C: ±0.2 nH	20	0.065	18.0	1150
	LQW15AN1N7D80D	1.7	D: ±0.5 nH	20	0.065	18.0	1150
	LQW15AN2N2B80D	2.2	B: ±0.1 nH	30	0.022	15.5	2530
	LQW15AN2N2C80D	2.2	C: ±0.2 nH	30	0.022	15.5	2530
	LQW15AN2N2D80D	2.2	D: ±0.5 nH	30	0.022	15.5	2530
	LQW15AN2N2G80D	2.2	G: ±2%	30	0.022	15.5	2530
	LQW15AN2N3B80D	2.3	B: ±0.1 nH	30	0.022	15.5	2530
	LQW15AN2N3C80D	2.3	C: ±0.2 nH	30	0.022	15.5	2530
	LQW15AN2N3D80D	2.3	D: ±0.5 nH	30	0.022	15.5	2530
	LQW15AN2N3G80D	2.3	G: ±2%	30	0.022	15.5	2530

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Customer Part number	Murata Part number	Nominal value	ctance Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	Rated current (mA)*1
	LQW15AN2N4B80D	(nH) 2.4	B: ±0.1 nH	30	0.022	15.5	2530
	LQW15AN2N4C80D	2.4	C: ±0.1 nm	30	0.022	15.5	2530
	LQW15AN2N4D80D	2.4	D: ±0.5 nH	30	0.022	15.5	2530
	LQW15AN2N4G80D	2.4	G: ±2%	30	0.022	15.5	2530
	LQW15AN2N5B80D	2.5	B: ±0.1 nH	30	0.022	15.5	2100
	LQW15AN2N5C80D	2.5	C: ±0.1 nm	30	0.030	15.5	2100
	LQW15AN2N5D80D	2.5	D: ±0.5 nH	30	0.030	15.5	2100
	LQW15AN2N5G80D	2.5	G: ±2%	30	0.030	15.5	2100
	LQW15AN2N6B80D	2.6	B: ±0.1 nH	30	0.035	14.5	1950
	LQW15AN2N6C80D	2.6	C: ±0.1 nm	30	0.035	14.5	1950
	LQW15AN2N6D80D	2.6	D: ±0.5 nH	30	0.035	14.5	1950
	LQW15AN2N6G80D	2.6	G: ±2%	30	0.035	14.5	1950
	LQW15AN2N7B80D	2.7	B: ±0.1 nH	28	0.033	14.0	1500
	LQW15AN2N7C80D	2.7	C: ±0.1 nH	28	0.047	14.0	1500
	LQW15AN2N7C80D	2.7	D: ±0.5 nH	28	0.047	14.0	1500
	LQW15AN2N7G80D	2.7	G: ±2%	28	0.047	14.0	
	· · · · · · · · · · · · · · · · · · ·						1500
	LQW15AN2N8B80D	2.8	B: ±0.1 nH	27	0.047 0.047	13.5	1500
	LQW15AN2N8C80D	2.8	C: ±0.2 nH	27		13.5	1500
	LQW15AN2N8D80D	2.8	D: ±0.5 nH	27	0.047	13.5	1500
	LQW15AN2N8G80D	2.8	G: ±2%	27	0.047	13.5	1500
	LQW15AN2N9B80D	2.9	B: ±0.1 nH	25	0.047	12.5	1500
	LQW15AN2N9C80D	2.9	C: ±0.2 nH	25	0.047	12.5	1500
	LQW15AN2N9D80D	2.9	D: ±0.5 nH	25	0.047	12.5	1500
	LQW15AN2N9G80D	2.9	G: ±2%	25	0.047	12.5	1500
	LQW15AN3N0B80D	3.0	B: ±0.1 nH	20	0.063	12.5	1350
	LQW15AN3N0C80D	3.0	C: ±0.2 nH	20	0.063	12.5	1350
	LQW15AN3N0D80D	3.0	D: ±0.5 nH	20	0.063	12.5	1350
	LQW15AN3N0G80D	3.0	G: ±2%	20	0.063	12.5	1350
	LQW15AN3N3B80D	3.3	B: ±0.1 nH	30	0.030	14.0	2000
	LQW15AN3N3C80D	3.3	C: ±0.2 nH	30	0.030	14.0	2000
	LQW15AN3N3D80D	3.3	D: ±0.5 nH	30	0.030	14.0	2000
	LQW15AN3N3G80D	3.3	G: ±2%	30	0.030	14.0	2000
	LQW15AN3N4B80D	3.4	B: ±0.1 nH	30	0.030	10.0	1950
	LQW15AN3N4C80D	3.4	C: ±0.2 nH	30	0.030	10.0	1950
	LQW15AN3N4D80D	3.4	D: ±0.5 nH	30	0.030	10.0	1950
	LQW15AN3N4G80D	3.4	G: ±2%	30	0.030	10.0	1950
	LQW15AN3N5B80D	3.5	B: ±0.1 nH	30	0.030	10.0	1950
	LQW15AN3N5C80D	3.5	C: ±0.2 nH	30	0.030	10.0	1950
	LQW15AN3N5D80D	3.5	D: ±0.5 nH	30	0.030	10.0	1950
	LQW15AN3N5G80D	3.5	G: ±2%	30	0.030	10.0	1950
	LQW15AN3N6B80D	3.6	B: ±0.1 nH	30	0.030	10.0	1950
	LQW15AN3N6C80D	3.6	C: ±0.2 nH	30	0.030	10.0	1950
	LQW15AN3N6D80D	3.6	D: ±0.5 nH	30	0.030	10.0	1950
	LQW15AN3N6G80D	3.6	G: ±2%	30	0.030	10.0	1950
	LQW15AN3N7B80D	3.7	B: ±0.1 nH	35	0.030	10.0	1950
	LQW15AN3N7C80D	3.7	C: ±0.2 nH	35	0.030	10.0	1950

		Inductance					
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	Rated current (mA)*1
	LQW15AN3N7D80D	3.7	D: ±0.5 nH	35	0.030	10.0	1950
	LQW15AN3N7G80D	3.7	G: ±2%	35	0.030	10.0	1950
	LQW15AN3N8B80D	3.8	B: ±0.1 nH	35	0.030	10.0	1950
	LQW15AN3N8C80D	3.8	C: ±0.2 nH	35	0.030	10.0	1950
	LQW15AN3N8D80D	3.8	D: ±0.5 nH	35	0.030	10.0	1950
	LQW15AN3N8G80D	3.8	G: ±2%	35	0.030	10.0	1950
	LQW15AN3N9B80D	3.9	B: ±0.1 nH	35	0.030	10.0	1950
	LQW15AN3N9C80D	3.9	C: ±0.2 nH	35	0.030	10.0	1950
	LQW15AN3N9D80D	3.9	D: ±0.5 nH	35	0.030	10.0	1950
	LQW15AN3N9G80D	3.9	G: ±2%	35	0.030	10.0	1950
	LQW15AN4N0B80D	4.0	B: ±0.1 nH	30	0.030	10.0	1950
	LQW15AN4N0C80D	4.0	C: ±0.2 nH	30	0.030	10.0	1950
	LQW15AN4N0D80D	4.0	D: ±0.5 nH	30	0.030	10.0	1950
	LQW15AN4N0G80D	4.0	G: ±2%	30	0.030	10.0	1950
	LQW15AN4N1B80D	4.1	B: ±0.1 nH	30	0.044	9.6	1800
	LQW15AN4N1C80D	4.1	C: ±0.2 nH	30	0.044	9.6	1800
	LQW15AN4N1D80D	4.1	D: ±0.5 nH	30	0.044	9.6	1800
	LQW15AN4N1G80D	4.1	G: ±2%	30	0.044	9.6	1800
	LQW15AN4N2B80D	4.2	B: ±0.1 nH	30	0.044	9.6	1800
	LQW15AN4N2C80D	4.2	C: ±0.2 nH	30	0.044	9.6	1800
	LQW15AN4N2D80D	4.2	D: ±0.5 nH	30	0.044	9.6	1800
	LQW15AN4N2G80D	4.2	G: ±2%	30	0.044	9.6	1800
	LQW15AN4N3B80D	4.3	B: ±0.1 nH	32	0.044	9.6	1800
	LQW15AN4N3C80D	4.3	C: ±0.2 nH	32	0.044	9.6	1800
	LQW15AN4N3D80D	4.3	D: ±0.5 nH	32	0.044	9.6	1800
	LQW15AN4N3G80D	4.3	G: ±2%	32	0.044	9.6	1800
	LQW15AN4N4B80D	4.4	B: ±0.1 nH	34	0.052	9.6	1600
	LQW15AN4N4C80D	4.4	C: ±0.2 nH	34	0.052	9.6	1600
	LQW15AN4N4D80D	4.4	D: ±0.5 nH	34	0.052	9.6	1600
	LQW15AN4N4G80D	4.4	G: ±2%	34	0.052	9.6	1600
	LQW15AN4N5B80D	4.5	B: ±0.1 nH	34	0.060	9.6	1450
	LQW15AN4N5C80D	4.5	C: ±0.2 nH	34	0.060	9.6	1450
	LQW15AN4N5D80D	4.5	D: ±0.5 nH	34	0.060	9.6	1450
	LQW15AN4N5G80D	4.5	G: ±2%	34	0.060	9.6	1450
	LQW15AN4N6B80D	4.6	B: ±0.1 nH	32	0.060	9.6	1450
	LQW15AN4N6C80D	4.6	C: ±0.2 nH	32	0.060	9.6	1450
	LQW15AN4N6D80D	4.6	D: ±0.5 nH	32	0.060	9.6	1450
	LQW15AN4N6G80D	4.6	G: ±2%	32	0.060	9.6	1450
	LQW15AN4N7B80D	4.7	B: ±0.1 nH	31	0.071	8.0	1200
	LQW15AN4N7C80D	4.7	C: ±0.2 nH	31	0.071	8.0	1200
	LQW15AN4N7D80D	4.7	D: ±0.5 nH	31	0.071	8.0	1200
	LQW15AN4N7G80D	4.7	G: ±2%	31	0.071	8.0	1200
	LQW15AN4N8B80D	4.8	B: ±0.1 nH	30	0.071	8.0	1200
	LQW15AN4N8C80D	4.8	C: ±0.2 nH	30	0.071	8.0	1200
	LQW15AN4N8D80D	4.8	D: ±0.5 nH	30	0.071	8.0	1200
	LQW15AN4N8G80D	4.8	G: ±2%	30	0.071	8.0	1200

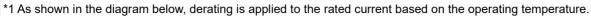
		Inductance		l l			
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	Rated current (mA)*1
	LQW15AN4N9B80D	4.9	B: ±0.1 nH	27	0.071	8.0	1200
	LQW15AN4N9C80D	4.9	C: ±0.2 nH	27	0.071	8.0	1200
	LQW15AN4N9D80D	4.9	D: ±0.5 nH	27	0.071	8.0	1200
	LQW15AN4N9G80D	4.9	G: ±2%	27	0.071	8.0	1200
	LQW15AN5N0B80D	5.0	B: ±0.1 nH	32	0.040	10.0	1770
	LQW15AN5N0C80D	5.0	C: ±0.2 nH	32	0.040	10.0	1770
	LQW15AN5N0D80D	5.0	D: ±0.5 nH	32	0.040	10.0	1770
	LQW15AN5N0G80D	5.0	G: ±2%	32	0.040	10.0	1770
	LQW15AN5N1B80D	5.1	B: ±0.1 nH	35	0.040	8.0	1770
	LQW15AN5N1C80D	5.1	C: ±0.2 nH	35	0.040	8.0	1770
	LQW15AN5N1D80D	5.1	D: ±0.5 nH	35	0.040	8.0	1770
	LQW15AN5N1G80D	5.1	G: ±2%	35	0.040	8.0	1770
	LQW15AN5N2B80D	5.2	B: ±0.1 nH	35	0.040	8.0	1770
	LQW15AN5N2C80D	5.2	C: ±0.2 nH	35	0.040	8.0	1770
	LQW15AN5N2D80D	5.2	D: ±0.5 nH	35	0.040	8.0	1770
	LQW15AN5N2G80D	5.2	G: ±2%	35	0.040	8.0	1770
	LQW15AN5N3B80D	5.3	B: ±0.1 nH	35	0.040	8.0	1770
	LQW15AN5N3C80D	5.3	C: ±0.2 nH	35	0.040	8.0	1770
	LQW15AN5N3D80D	5.3	D: ±0.5 nH	35	0.040	8.0	1770
	LQW15AN5N3G80D	5.3	G: ±2%	35	0.040	8.0	1770
	LQW15AN5N4B80D	5.4	B: ±0.1 nH	35	0.040	8.0	1770
	LQW15AN5N4C80D	5.4	C: ±0.2 nH	35	0.040	8.0	1770
	LQW15AN5N4D80D	5.4	D: ±0.5 nH	35	0.040	8.0	1770
	LQW15AN5N4G80D	5.4	G: ±2%	35	0.040	8.0	1770
	LQW15AN5N5B80D	5.5	B: ±0.1 nH	35	0.040	8.0	1770
	LQW15AN5N5C80D	5.5	C: ±0.2 nH	35	0.040	8.0	1770
	LQW15AN5N5D80D	5.5	D: ±0.5 nH	35	0.040	8.0	1770
	LQW15AN5N5G80D	5.5	G: ±2%	35	0.040	8.0	1770
	LQW15AN5N6B80D	5.6	B: ±0.1 nH	35	0.040	8.0	1770
	LQW15AN5N6C80D	5.6	C: ±0.2 nH	35	0.040	8.0	1770
	LQW15AN5N6D80D	5.6	D: ±0.5 nH	35	0.040	8.0	1770
	LQW15AN5N6G80D	5.6	G: ±2%	35	0.040	8.0	1770
	LQW15AN5N7B80D	5.7	B: ±0.1 nH	30	0.040	8.0	1770
	LQW15AN5N7C80D	5.7	C: ±0.2 nH	30	0.040	8.0	1770
	LQW15AN5N7D80D	5.7	D: ±0.5 nH	30	0.040	8.0	1770
	LQW15AN5N7G80D	5.7	G: ±2%	30	0.040	8.0	1770
	LQW15AN5N8B80D	5.8	B: ±0.1 nH	30	0.040	8.0	1770
	LQW15AN5N8C80D	5.8	C: ±0.2 nH	30	0.040	8.0	1770
	LQW15AN5N8D80D	5.8	D: ±0.5 nH	30	0.040	8.0	1770
	LQW15AN5N8G80D	5.8	G: ±2%	30	0.040	8.0	1770
	LQW15AN5N9B80D	5.9	B: ±0.1 nH	30	0.040	8.0	1770
	LQW15AN5N9C80D	5.9	C: ±0.2 nH	30	0.040	8.0	1770
	LQW15AN5N9D80D	5.9	D: ±0.5 nH	30	0.040	8.0	1770
	LQW15AN5N9G80D	5.9	G: ±2%	30	0.040	8.0	1770
	LQW15AN6N0B80D	6.0	B: ±0.1 nH	32	0.056	8.0	1600
	LQW15AN6N0C80D	6.0	C: ±0.2 nH	32	0.056	8.0	1600

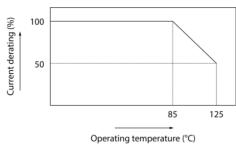
		Indu	ctance				
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	Rated current (mA)*1
	LQW15AN6N0D80D	6.0	D: ±0.5 nH	32	0.056	8.0	1600
	LQW15AN6N0G80D	6.0	G: ±2%	32	0.056	8.0	1600
	LQW15AN6N1B80D	6.1	B: ±0.1 nH	32	0.056	8.0	1600
	LQW15AN6N1C80D	6.1	C: ±0.2 nH	32	0.056	8.0	1600
	LQW15AN6N1D80D	6.1	D: ±0.5 nH	32	0.056	8.0	1600
	LQW15AN6N1G80D	6.1	G: ±2%	32	0.056	8.0	1600
	LQW15AN6N2B80D	6.2	B: ±0.1 nH	33	0.056	8.0	1600
	LQW15AN6N2C80D	6.2	C: ±0.2 nH	33	0.056	8.0	1600
	LQW15AN6N2D80D	6.2	D: ±0.5 nH	33	0.056	8.0	1600
	LQW15AN6N2G80D	6.2	G: ±2%	33	0.056	8.0	1600
	LQW15AN6N3G80D	6.3	G: ±2%	32	0.057	7.8	1600
	LQW15AN6N3J80D	6.3	J: ±5%	32	0.057	7.8	1600
	LQW15AN6N4G80D	6.4	G: ±2%	33	0.065	7.0	1380
	LQW15AN6N4J80D	6.4	J: ±5%	33	0.065	7.0	1380
	LQW15AN6N5G80D	6.5	G: ±2%	32	0.065	7.0	1380
	LQW15AN6N5J80D	6.5	J: ±5%	32	0.065	7.0	1380
	LQW15AN6N6G80D	6.6	G: ±2%	30	0.078	7.0	1280
	LQW15AN6N6J80D	6.6	J: ±5%	30	0.078	7.0	1280
	LQW15AN6N7G80D	6.7	G: ±2%	30	0.078	7.0	1280
	LQW15AN6N7J80D	6.7	J: ±5%	30	0.078	7.0	1280
	LQW15AN6N8G80D	6.8	G: ±2%	30	0.068	7.0	1450
	LQW15AN6N8J80D	6.8	J: ±5%	30	0.068	7.0	1450
	LQW15AN6N9G80D	6.9	G: ±2%	32	0.069	8.5	1420
	LQW15AN6N9J80D	6.9	J: ±5%	32	0.069	8.5	1420
	LQW15AN7N0G80D	7.0	G: ±2%	33	0.069	8.0	1420
	LQW15AN7N0J80D	7.0	J: ±5%	33	0.069	8.0	1420
	LQW15AN7N1G80D	7.1	G: ±2%	32	0.069	7.0	1420
	LQW15AN7N1J80D	7.1	J: ±5%	32	0.069	7.0	1420
	LQW15AN7N2G80D	7.2	G: ±2%	32	0.050	7.0	1700
	LQW15AN7N2J80D	7.2	J: ±5%	32	0.050	7.0	1700
	LQW15AN7N3G80D	7.3	G: ±2%	32	0.050	7.0	1700
	LQW15AN7N3J80D	7.3	J: ±5%	32	0.050	7.0	1700
	LQW15AN7N4G80D	7.4	G: ±2%	30	0.050	7.0	1700
	LQW15AN7N4J80D	7.4	J: ±5%	30	0.050	7.0	1700
	LQW15AN7N5G80D	7.5	G: ±2%	35	0.050	7.0	1700
	LQW15AN7N5J80D	7.5	J: ±5%	35	0.050	7.0	1700
	LQW15AN7N6G80D	7.6	G: ±2%	30	0.050	7.0	1700
	LQW15AN7N6J80D	7.6	J: ±5%	30	0.050	7.0	1700
	LQW15AN7N7G80D	7.7	G: ±2%	30	0.050	7.0	1700
	LQW15AN7N7J80D	7.7	J: ±5%	30	0.050	7.0	1700
	LQW15AN7N8G80D	7.8	G: ±2%	30	0.050	7.0	1700
	LQW15AN7N8J80D	7.8	J: ±5%	30	0.050	7.0	1700
	LQW15AN7N9G80D	7.9	G: ±2%	30	0.050	7.0	1700
	LQW15AN7N9J80D	7.9	J: ±5%	30	0.050	7.0	1700
	LQW15AN8N0G80D	8.0	G: ±2%	30	0.050	7.0	1700
	LQW15AN8N0J80D	8.0	J: ±5%	30	0.050	7.0	1700

		Indu	ctance				
Customer Part number	Murata Part number	Nominal value	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	Rated current (mA)*1
		(nH)			, ,	,	` '
	LQW15AN8N1G80D	8.1	G: ±2%	32	0.069	6.5	1500
	LQW15AN8N1J80D	8.1	J: ±5%	32	0.069	6.5	1500
	LQW15AN8N2G80D	8.2	G: ±2%	32	0.069	6.5	1500
	LQW15AN8N2J80D	8.2	J: ±5%	32	0.069	6.5	1500
	LQW15AN8N3G80D	8.3	G: ±2%	32	0.069	6.5	1500
	LQW15AN8N3J80D	8.3	J: ±5%	32	0.069	6.5	1500
	LQW15AN8N4G80D	8.4	G: ±2%	32	0.069	6.5	1500
	LQW15AN8N4J80D	8.4	J: ±5%	32	0.069	6.5	1500
	LQW15AN8N5G80D	8.5	G: ±2%	32	0.069	6.5	1500
_	LQW15AN8N5J80D	8.5	J: ±5%	32	0.069	6.5	1500
	LQW15AN8N6G80D	8.6	G: ±2%	31	0.070	6.5	1420
	LQW15AN8N6J80D	8.6	J: ±5%	31	0.070	6.5	1420
	LQW15AN8N7G80D	8.7	G: ±2%	31	0.070	6.5	1420
	LQW15AN8N7J80D	8.7	J: ±5%	31	0.070	6.5	1420
	LQW15AN8N8G80D	8.8	G: ±2%	31	0.070	6.5	1420
	LQW15AN8N8J80D	8.8	J: ±5%	31	0.070	6.5	1420
	LQW15AN8N9G80D	8.9	G: ±2%	31	0.070	6.5	1420
	LQW15AN8N9J80D	8.9	J: ±5%	31	0.070	6.5	1420
	LQW15AN9N0G80D	9.0	G: ±2%	30	0.070	6.5	1420
	LQW15AN9N0J80D	9.0	J: ±5%	30	0.070	6.5	1420
	LQW15AN9N1G80D	9.1	G: ±2%	32	0.080	6.5	1400
	LQW15AN9N1J80D	9.1	J: ±5%	32	0.080	6.5	1400
	LQW15AN9N2G80D	9.2	G: ±2%	32	0.081	6.0	1400
	LQW15AN9N2J80D	9.2	J: ±5%	32	0.081	6.0	1400
	LQW15AN9N3G80D	9.3	G: ±2%	34	0.081	6.0	1400
	LQW15AN9N3J80D	9.3	J: ±5%	34	0.081	6.0	1400
	LQW15AN9N4G80D	9.4	G: ±2%	33	0.081	6.0	1400
	LQW15AN9N4J80D	9.4	J: ±5%	33	0.081	6.0	1400
	LQW15AN9N5G80D	9.5	G: ±2%	32	0.081	6.0	1400
	LQW15AN9N5J80D	9.5	J: ±5%	32	0.081	6.0	1400
	LQW15AN9N6G80D	9.6	G: ±2%	33	0.081	6.0	1400
	LQW15AN9N6J80D	9.6	J: ±5%	33	0.081	6.0	1400
	LQW15AN9N7G80D	9.7	G: ±2%	33	0.081	6.0	1400
	LQW15AN9N7J80D	9.7	J: ±5%	33	0.081	6.0	1400
	LQW15AN9N8G80D	9.8	G: ±2%	34	0.081	6.0	1400
	LQW15AN9N8J80D	9.8	J: ±5%	34	0.081	6.0	1400
	LQW15AN9N9G80D	9.9	G: ±2%	32	0.081	6.0	1400
	LQW15AN9N9J80D	9.9	J: ±5%	32	0.081	6.0	1400
	LQW15AN10NG80D	10	G: ±2%	31	0.081	6.0	1400
	LQW15AN10NJ80D	10	J: ±5%	31	0.081	6.0	1400
	LQW15AN11NG80D	11	G: ±2%	32	0.083	6.2	1400
	LQW15AN11NJ80D	11	J: ±5%	32	0.083	6.2	1400
	LQW15AN12NG80D	12	G: ±2%	30	0.093	5.2	1240
	LQW15AN12NJ80D	12	J: ±5%	30	0.093	5.2	1240
	LQW15AN13NG80D	13	G: ±2%	30	0.093	5.2	1240
	LQW15AN13NJ80D	13	J: ±5%	30	0.093	5.2	1240

		Inductance				0.15	
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	Rated current (mA)*1
	LQW15AN14NG80D	14	G: ±2%	31	0.111	5.2	1150
	LQW15AN14NJ80D	14	J: ±5%	31	0.111	5.2	1150
	LQW15AN15NG80D	15	G: ±2%	31	0.114	5.5	1150
	LQW15AN15NJ80D	15	J: ±5%	31	0.114	5.5	1150
	LQW15AN16NG80D	16	G: ±2%	31	0.126	5.0	1000
	LQW15AN16NJ80D	16	J: ±5%	31	0.126	5.0	1000
	LQW15AN17NG80D	17	G: ±2%	30	0.126	5.0	1000
	LQW15AN17NJ80D	17	J: ±5%	30	0.126	5.0	1000
	LQW15AN18NG80D	18	G: ±2%	30	0.130	5.2	1050
	LQW15AN18NJ80D	18	J: ±5%	30	0.130	5.2	1050
	LQW15AN19NG80D	19	G: ±2%	30	0.156	5.0	920
	LQW15AN19NJ80D	19	J: ±5%	30	0.156	5.0	920
	LQW15AN20NG80D	20	G: ±2%	30	0.186	4.5	800
	LQW15AN20NJ80D	20	J: ±5%	30	0.186	4.5	800
	LQW15AN21NG80D	21	G: ±2%	30	0.202	4.5	780
	LQW15AN21NJ80D	21	J: ±5%	30	0.202	4.5	780
	LQW15AN22NG80D	22	G: ±2%	30	0.202	4.5	780
	LQW15AN22NJ80D	22	J: ±5%	30	0.202	4.5	780
	LQW15AN23NG80D	23	G: ±2%	29	0.201	4.5	760
	LQW15AN23NJ80D	23	J: ±5%	29	0.201	4.5	760
	LQW15AN24NG80D	24	G: ±2%	31	0.212	4.0	770
	LQW15AN24NJ80D	24	J: ±5%	31	0.212	4.0	770
	LQW15AN25NG80D	25	G: ±2%	31	0.221	4.1	750
	LQW15AN25NJ80D	25	J: ±5%	31	0.221	4.1	750
	LQW15AN26NG80D	26	G: ±2%	29	0.282	4.1	720
	LQW15AN26NJ80D	26	J: ±5%	29	0.282	4.1	720
	LQW15AN27NG80D	27	G: ±2%	30	0.288	4.0	680
	LQW15AN27NJ80D	27	J: ±5%	30	0.288	4.0	680
	LQW15AN30NG80D	30	G: ±2%	30	0.309	3.8	660
	LQW15AN30NJ80D	30	J: ±5%	30	0.309	3.8	660
	LQW15AN33NG80D	33	G: ±2%	30	0.336	3.6	620
	LQW15AN33NJ80D	33	J: ±5%	30	0.336	3.6	620
	LQW15AN36NG80D	36	G: ±2%	30	0.431	3.5	540
	LQW15AN36NJ80D	36	J: ±5%	30	0.431	3.5	540
	LQW15AN39NG80D	39	G: ±2%	28	0.456	3.4	530
	LQW15AN39NJ80D	39	J: ±5%	28	0.456	3.4	530
	LQW15AN43NG80D	43	G: ±2%	30	0.516	3.4	515
	LQW15AN43NJ80D	43	J: ±5%	30	0.516	3.4	515
	LQW15AN47NG80D	47	G: ±2%	25	0.648	3.2	440
	LQW15AN47NJ80D	47	J: ±5%	25	0.648	3.2	440
	LQW15AN51NG80D	51	G: ±2%	25	0.696	2.9	415
	LQW15AN51NJ80D	51	J: ±5%	25	0.696	2.9	415
	LQW15AN53NG80D	53	G: ±2%	25	0.696	2.9	415
	LQW15AN53NJ80D	53	J: ±5%	25	0.696	2.9	415
	LQW15AN56NG80D	56	G: ±2%	25	0.996	2.9	340
	LQW15AN56NJ80D	56	J: ±5%	25	0.996	2.9	340
	LG 11 IOM NOUNDOOD	50	U. ±U/0	20	0.000	2.0	J - U

		Inductance			DC	Colf recoment	Rated
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (GHz min.)	current (mA)*1
	LQW15AN68NG80D	68	G: ±2%	25	1.128	2.5	320
	LQW15AN68NJ80D	68	J: ±5%	25	1.128	2.5	320
	LQW15AN75NG80D	75	G: ±2%	25	1.224	2.4	320
	LQW15AN75NJ80D	75	J: ±5%	25	1.224	2.4	320

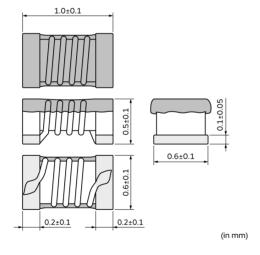




4. Testing Conditions

Unless otherwise specified	Temperature: ordinary temperature (15°C to 35°C) Humidity: ordinary humidity [25% to 85% (RH)]
	Temperature: 20°C±2°C Humidity: 60% to 70% (RH) Atmospheric pressure: 86 kPa to 106 kPa

5. Appearance and Dimensions



Unit mass (typical value): 0.0009 g

6. Marking

No marking.



7. Electrical Performance

No.	Item	Specification		Test method		
7.1	Inductance	Meet chapter 3 ratings.	Measuring equipment: Keysight E4991A or the equivalent Measuring frequency:			
			Inductance	100 MHz		
			Q	250 MHz 1.3 nH to 43 nH		
				200 MHz 47 nH to 75 nH		
			Measuring conditions: Measurement signal level: Approx. 0 dBm Measurement terminal distance: 0.5 mm Electrical length: 10.0 mm Weight: Approx. 1 N to 3 N Measuring fixture: Keysight 16197A Position the chip coil under test as shown in the measuring example below and connect it to the electrode by applying weight. Measurement example:			
7.2	Q	Meet chapter 3 ratings.	_ ivicasurement exam	ipie.		
			Measuring method:	Product Guide See "Electrical performance:		
			Measuring method "16. Appendix".	for inductance/Q" in the chapter		
7.3	DC resistance	Meet chapter 3 ratings.	Measuring equipme	ent: digital multimeter		
7.4	Self-resonant frequency	Meet chapter 3 ratings.	Measuring equipme equivalent	ent: Keysight N5230 or the		
7.5	Rated current	Product temperature rise: 40°C max.	Apply the rated cur	rent specified in chapter 3.		

8. Mechanical Performance

No.	Item	Specification	Test method
8.1	Shear test	No significant mechanical damage or no sign of electrode peeling off shall be observed.	Test substrate: glass-epoxy substrate Force application direction:
			Applying force: 5 N Holding time: 5 s±1 s

No.	Item	Specification	Test method	
8.2	Bending test	No significant mechanical damage or no sign of electrode peeling off shall be observed.	Test substrate: glass-epoxy substrate (100 mm × 40 mm × 0.8 mm) Pressurizing speed: 1 mm/s Deflection: 2 mm Holding time: 5 s	
			Pressure jig	
			Deflection Product (in mm)	
8.3	Vibration	Appearance shall have no significant mechanical damage.	Oscillation frequency: 10 Hz to 55 Hz to 10 Hz, for approx. 1 min Total amplitude: 1.5 mm Test time: 3 directions perpendicular to each other, 2 h for each direction (6 h in total)	
8.4	Solderability	90% or more of the outer electrode shall be covered with new solder seamlessly.	Flux: immersed in ethanol solution [including an activator with a chlorine conversion value of 0.06(wt)%] with a rosin content of 25(wt)% for 5 s to 10 s. Solder: Sn-3.0Ag-0.5Cu solder Pre-heating: 150°C±10°C/60 s to 90 s Solder temperature: 240°C±5°C Immersion time: 3 s±1 s	
8.5	Resistance to soldering heat	Appearance: No significant mechanical damage shall be observed. Inductance change rate: within ±5%	Flux: immersed in ethanol solution [including an activator with a chlorine conversion value of 0.06(wt)%] with a rosin content of 25(wt)% for 5 s to 10 s. Solder: Sn-3.0Ag-0.5Cu solder Pre-heating: 150°C±10°C/60 s to 90 s Solder temperature: 270°C±5°C Immersion time: 10 s±1 s Post-treatment: left at a room condition for 24 h±2 h	

9. Environmental Performance

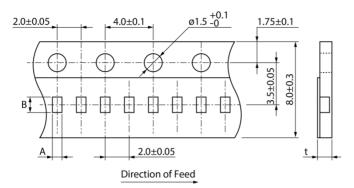
The product is soldered on a substrate for test.

No.	Item	Specification	Test method
9.1	Heat resistance	Appearance: No significant mechanical damage shall be observed. Inductance change rate: within ±5% Q change rate: within ±20%	Temperature: 125°C±2°C Test time: 1000 h (+48 h, -0 h) Post-treatment: left at a room condition for 24 h±2 h
9.2	Cold resistance	Appearance: No significant mechanical damage shall be observed. Inductance change rate: within ±5% Q change rate: within ±20%	Temperature: -55°C±2°C Test time: 1000 h (+48 h, -0 h) Post-treatment: left at a room condition for 24 h±2 h
9.3	Humidity	Appearance: No significant mechanical damage shall be observed. Inductance change rate: within ±5% Q change rate: within ±20%	Temperature: 70°C±2°C Humidity: 90% (RH) to 95% (RH) Test time: 1000 h (+48 h, -0 h) Post-treatment: left at a room condition for 24 h±2 h
9.4	Temperature cycle	Appearance: No significant mechanical damage shall be observed. Inductance change rate: within ±5% Q change rate: within ±20%	Single cycle conditions: Step 1: -55°C±2°C/30 min±3 min Step 2: ordinary temperature/10 min to 15 min Step 3: +125°C±2°C/30 min±3 min Step 4: ordinary temperature/10 min to 15 min Number of testing: 10 cycles Post-treatment: left at a room condition for 24 h±2 h



10. Specification of Packaging

10.1 Appearance and dimensions of tape (8 mm width/paper tape)



Α	0.75±0.03	
В	1.180±0.03	
t	0.80 max.	
	(in	mm)

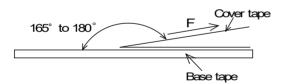
10.2 Taping specifications

Packing quantity (Standard quantity)	10000 pcs/reel
Packing method	The products are placed in embossed cavities of a base tape and sealed by a cover tape.
Feed hole position	The feed holes on the base tape are on the right side when the cover tape is pulled toward the user.
Joint	The base tape and the cover tape are seamless.
Number of missing products	Number of missing products within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

10.3 Break down force of tape

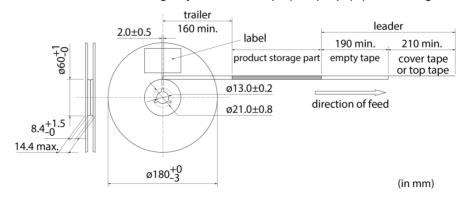
10.4 Peeling off force of cover tape

	•	
Speed of peeling off	300 mm/min	
Peeling off force	0.1 N to 0.6 N (The lower limit is for typical value.)	



10.5 Dimensions of leader section, trailer section and reel

A vacant section is provided in the leader (start) section and trailer (end) section of the tape for the product. The leader section is further provided with an area consisting only of the cover tape (or top tape). (See the diagram below.)





10.6 Marking for reel

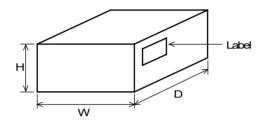
Customer part number, Murata part number, inspection number (*1), RoHS marking (*2), quantity, etc.

*1 Expression of inspection No. Occupangle Occupangl	(1) Factory code (2) Date First digit: year/last digit of year Second digit: month/Jan. to Sep.→1 to 9, Oct. to Dec.→O, N, D Third, Fourth digit: day (3) Serial No.
*2 Expression of RoHS marking ROHS- $\frac{Y}{(1)}$ $\frac{(\triangle)}{(2)}$: (1) RoHS regulation conformity (2) Murata classification number

10.7 Marking on outer box (corrugated box)

Customer name, purchasing order number, customer part number, Murata part number, RoHS marking (*2), quantity, etc.

10.8 Specification of outer box



Dimensions of outer box (mm)			Standard reel quantity	
W	D	Н	in outer box (reel)	
186 186 93 5				
* Above outer box size is typical. It depends on a				

^{*} Above outer box size is typical. It depends on a quantity of an order.

11. ACaution

11.1 Limitation of applications

The products listed in the reference specification (hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the reference specification (hereinafter called as the "Specific Application"). We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety. Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US*).

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Power plant control equipment
- (5) Medical equipment
- (6) Transportation equipment
- (7) Traffic control equipment
- (8) Disaster prevention/security equipment
- (9) Industrial data-processing equipment
- (10) Combustion/explosion control equipment
- (11) Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the reference specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: https://www.murata.com/contactform

* We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the reference specification without any exception. Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).



11.2 Precautions on rating

Avoid using in exceeded the rated temperature range, rated voltage, or rated current. Usage when the ratings are exceeded could lead to wire breakage, burning, or other serious fault.

11.3 Inrush current

If an inrush current (or pulse current or rush current) that significantly exceeds the rated current is applied to the product, overheating could occur, resulting in wire breakage, burning, or other serious fault.

11.4 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

12. Precautions for Use

This product is for use only with reflow soldering. It is designed to be mounted by soldering. If you want to use other mounting method, for example, using a conductive adhesive, please consult us beforehand.

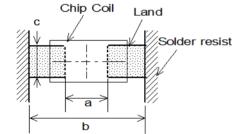
Also, if repeatedly subjected to temperature cycles or other thermal stress, due to the difference in the coefficient of thermal expansion with the mounting substrate, the solder (solder fillet part) in the mounting part may crack.

The occurrence of cracks due to thermal stress is affected by the size of the land where mounted, the solder volume, and the heat dissipation of the mounting substrate. Carefully design it when a large change in ambient temperature is assumed.

12.1 Land dimensions

The following diagram shows the recommended land dimensions for reflow soldering.

The land dimensions are designed in consideration of electrical characteristics and mountability. Use of other land dimensions may preclude achievement of performance. In some cases, it may result in poor solderability, including positional shift. If you use other land pattern, consider it adequately.



а	0.6	
b	1.42	
С	0.66	
	(in m	m)

12.2 Flux and solder used

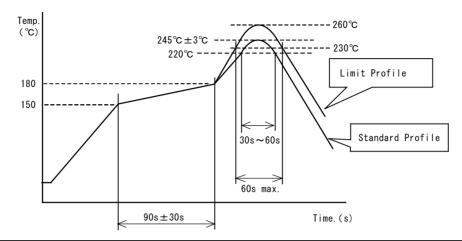
Flux	 Use a rosin-based flux that includes an activator with a chlorine conversion value of 0.06 mass% to 0.1 mass%. Do not use a highly acidic flux with a halide content exceeding 0.2 mass% (chlorine conversion value). Do not use a water-soluble flux.
Solder	 Use Sn-3.0Ag-0.5Cu solder. Standard thickness of solder paste: 50 μm to 100 μm

If you want to use a flux other than the above, please consult our technical department.



12.3 Soldering conditions (reflow)

- Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max.
 - Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max. Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of product quality.
- Standard soldering profile and the limit soldering profile is as follows.
 The excessive limit soldering conditions may cause leaching of the electrode and/or resulting in the deterioration of product quality.



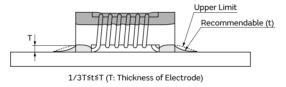
	Standard profile	Limit profile
Pre-heating	150°C to 180°C/90 s±30 s	150°C to 180°C/90 s±30 s
Heating	Above 220°C/30 s to 60 s	Above 230°C/60 s max.
Peak temperature	245°C±3°C	260°C/10 s
Number of reflow cycles	2 times	2 times

12.4 Reworking with soldering iron

Do not perform reworking with a soldering iron on this product.

12.5 Solder volume

Solder shall be used not to increase the volume too much.



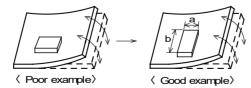
An increased solder volume increases mechanical stress on the product. Exceeding solder volume may cause the failure of mechanical or electrical performance.

12.6 Product's location

The following shall be considered when designing and laying out PCBs.

(1) PCB shall be designed so that products are not subject to mechanical stress due to warping the board. [Products direction]

Products shall be located in the sideways direction (length: a < b) to the mechanical stress.





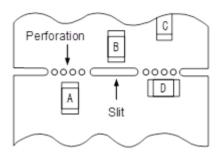
(2) Components location on PCB separation

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress

Contents of measures	Stress level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	
*4 A > D is valid when stone is added ventically to the mediantic according	

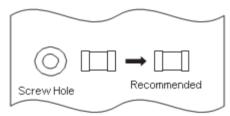
1 A > D is valid when stress is added vertically to the perforation as with hand separation. If a cutting disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.



(3) Mounting components near screw holes

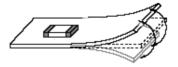
When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw.

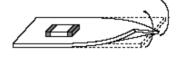
Mount the component in a position as far away from the screw holes as possible.



12.7 Handling of substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate. Excessive mechanical stress may cause cracking in the product.





Bending

Twisting



12.8 Cleaning

The product shall be cleaned under the following conditions.

- (1) The cleaning temperature shall be 60°C max. If isopropyl alcohol (IPA) is used, the cleaning temperature shall be 40°C max.
- (2) Perform ultrasonic cleaning under the following conditions. Exercise caution to prevent resonance phenomenon in mounted products and the PCB.

Item	Requirement
Power	20 W/L max.
Time	5 min max.
Frequency	28 kHz to 40 kHz

(3) Cleaner

Alcohol-based cleaner: IPA

Aqueous agent: PINE ALPHA ST-100S

(4) There shall be no residual flux or residual cleaner. When using aqueous agent, rinse the product with deionized water adequately and completely dry it so that no cleaner is left.

12.9 Storage and transportation

Storage period	Use the product within 12 months after delivery. If you do not use the product for more than 12 months, check solderability before using it.
Storage conditions	 The products shall be stored in a room not subject to rapid changes in temperature and humidity. The recommended temperature range is -10°C to +40°C. The recommended relative humidity range is 15% to 85%. Keeping the product in corrosive gases, such as sulfur, chlorine gas or acid may cause the poor solderability. Do not place the products directly on the floor; they should be placed on a palette so that they are not affected by humidity or dust. Avoid keeping the products in a place exposed to direct sunlight, heat or vibration. Do not keep products in bulk packaging. Bulk storage could result in collisions between the products or between the products and other parts, resulting in chipping or wire breakage. Avoid storing the product by itself bare (i.e. exposed directly to air).
Transportation	Excessive vibration and impact reduces the reliability of the products. Exercise caution when handling the products.

12.10 Resin coating (including moisture-proof coating)

When the product is coated/molded with resin, its electrical characteristics may change.

A wire breakage issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc.

Some resins contain impurities or hydrolyzable chlorine, which could result in corrosion of the conducting materials, leading to wire breakage.

So, please pay your careful attention when you select resin in case of coating/molding the products with the resin.

Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

12.11 Mounting conditions

Check the mounting condition before using.

Using mounting conditions (nozzles, equipment conditions, etc.) that are not suitable for products may lead to pick up errors, misalignment, or damage to the product.

With some types of mounting equipment, a support pin pushes up the product from the bottom of the base (paper) tape when the product is sucked with the pick-up nozzle. When using this type of equipment, detach the support pin to prevent the breaking of wire on the product.

In some cases, the laser recognition function of the mounting equipment may not recognize this product correctly. Please contact us when using laser recognition. (There is no problem with the permeation and reflection type.)

12.12 Operating environment

Do not use this product under the following environmental conditions as it may cause deterioration of product quality.

- (1) In the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl2, H2S, NH3, SO2, NO2, etc)
- (2) In the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) In the atmosphere where the temperature/humidity changes rapidly and it is easy to dew.

^{*} For other cleaning, consult our technical department.



12.13 Mounting density

If this product is placed near heat-generating products, be sure to implement sufficient heat-dissipating measures. If this product is subjected to a significant amount of heat from other products, this could adversely affect product quality, resulting in a circuit malfunction or failure of the mounted section. Also, be sure that the product is used in a manner so that the heat that the product is subjected to from other products does not exceed the upper limit of the rated operating temperature for the product.

12.14 Handling of product

- To prevent wire breakage, sharp objects such as tweezers, bristles of cleaning brushes, and other objects must not contact the winding section or the electrode section.
- Mechanical shock should not be applied to the products mounted on the board to prevent the breaking of the core.

13. **Note**

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

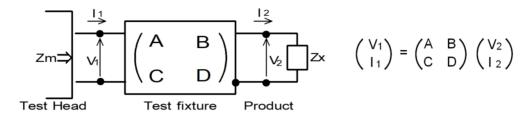


14. Appendix

Electrical performance: Measuring method for inductance/Q (Q measurement is applicable only when the Q value is included in the rating table.)

Perform measurement using the method described below. (Perform correction for the error deriving from the measuring terminal.)

(1) Residual elements and stray elements of the measuring terminal can be expressed by the F parameter for the 2-pole terminal as shown in the figure below.



(2) The product's impedance value (Zx) and measured impedance value (Zm) can be expressed as shown below, by using the respective current and voltage for input/output.

$$Zm = \frac{V_1}{I_1} \qquad Zx = \frac{V_2}{I_2}$$

(3) Thus, the relationship between the product's impedance value (Zx) and measured impedance value (Zm) is as follows.

	Here,
	$\alpha = D/A = 1$
	β = B/D = Zsm - (1 - Yom Zsm) Zss
$Z_{X}=\alpha \frac{Z_{M}-\beta}{1-Z_{M}\Gamma}$	Γ = C/A = Yom
	Zsm: measured impedance of short chip
	Zss: residual impedance of short chip (0.556 nH)
	Yom: measured admittance when measuring terminal is open

(4) Calculate inductance Lx and Qx using the equations shown below.

$Lx = \frac{Im (Zx)}{2\pi f}$ $Im (Zx)$	Lx: inductance of chip coil Qx: Q of chip coil
$Qx = \frac{IM(ZX)}{Re(ZX)}$	f: measuring frequency